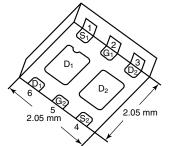
SiA914ADJ Vishay Siliconix



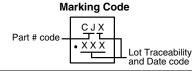
Dual N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω) Max.	I _D (A) ^a	Q _g (Typ.)		
20	0.043 at V _{GS} = 4.5 V	4.5			
	0.045 at V _{GS} = 3.7 V	4.5	3.5 nC		
	0.050 at V _{GS} = 2.5 V	4.5	3.5 110		
	0.063 at V _{GS} = 1.8 V	4.5			

PowerPAK SC-70-6 Dual



Ordering Information: SiA914ADJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

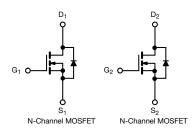


FEATURES

- TrenchFET[®] Power MOSFET
- Thermally Enhanced PowerPAK[®] SC-70 Package
 Small Footprint Area
 Low On-Resistance
- 100 % R_a Tested
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Portable Devices such as Smart Phones, Tablet PCs and Mobile Computing
- Load Switch
- DC/DC Converter
- Power Management



Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	20	V	
Gate-Source Voltage		V _{GS}	± 8		
	T _C = 25 °C		4.5 ^a		
Continuous Drain Current (T. 150 °C)	T _C = 70 °C	1	4.5 ^a	А	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	- I _D	4.5 ^{a, b, c}		
	T _A = 70 °C		4.3 ^{b, c}		
Pulsed Drain Current (t = 100 μs)		I _{DM}	30		
Continuous Source-Drain Diode Current	T _C = 25 °C		4.5 ^a		
	T _A = 25 °C	I _S	1.6 ^{b, c}		
Maximum Power Dissipation	T _C = 25 °C		7.8		
	T _C = 70 °C	P _D	5	w	
	T _A = 25 °C		1.9 ^{b, c}		
	T _A = 70 °C	1	1.2 ^{b, c}	1	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260		

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	52	65	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	12.5	16		

Notes

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 110 °C/W.

S13-1270-Rev. A, 27-May-13

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Document Number: 62872

For technical questions, contact: pmostechsupport@vishay.com

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Vishay Siliconix

SiA914ADJ

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		•	•				
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			18		1/00	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μΑ		- 2.5		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th})	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.4		0.9	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V			1	μA	
		V _{DS} = 20 V, V _{GS} = 0 V, T _J = 55 °C	°C 10		10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	10			А	
	D(on)	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 3.7 \text{ A}$		0.035	0.043	Ω	
	5	$V_{GS} = 3.7 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		0.036	0.045		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		0.040	0.050		
		V _{GS} = 1.8 V, I _D = 1 A		0.047	0.063		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 3.7 A		18		S	
Dynamic ^b			•				
Input Capacitance	C _{iss}			470		pF	
Output Capacitance	Coss	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		75			
Reverse Transfer Capacitance	C _{rss}			26		1.	
		$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 8 \text{ V}, \text{ I}_{D} = 6 \text{ A}$		8.2	12.5	nC	
Total Gate Charge	Qg			4.6	7		
Gate-Source Charge	Q _{gs}	V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 6 A		0.65			
Gate-Drain Charge	Q _{gd}			0.6			
Gate Resistance	R _g	f = 1 MHz	0.6	3	6	Ω	
Turn-On Delay Time	t _{d(on)}			7	15		
Rise Time	t _r	$V_{DD} = 10 \text{ V}, \text{ R}_{\text{I}} = 2.1 \Omega$		20	40	ns	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 4.8 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		25	50		
Fall Time	t _f			5	10		
Turn-On Delay Time	t _{d(on)}			5	10		
Rise Time	t _r	$V_{DD} = 10 \text{ V}, \text{ R}_{L} = 2.1 \Omega$		5	10		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 4.8 \text{ A}, V_{\text{GEN}} = 8 \text{ V}, R_g = 1 \Omega$		20	40		
Fall Time	t _f			5	10		
Drain-Source Body Diode Characteristic		L		L			
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			4.5		
Pulse Diode Forward Current (t = 100 µs)	I _{SM}				30	A	
Body Diode Voltage	V _{SD}	I _S = 4.8 A, V _{GS} = 0 V		0.85	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	<u> </u>		9.5	20	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	1		3	10	nC	
Reverse Recovery Fall Time	t _a	$I_F = 4.8 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		5	-		
Reverse Recovery Rise Time	t _b	1		4.5		ns	

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

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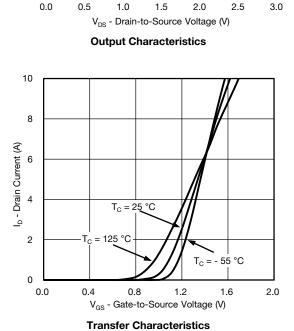
V_{GS} = 5 V thru 3 V V_{GŞ} = 2.5 V

(_{GS} = 2 V

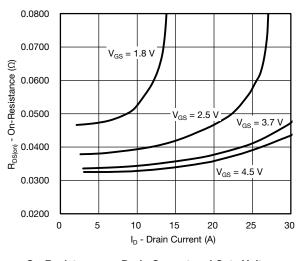
V_{GS} = 1.5 V

 $V_{GS} = 1 V$

600

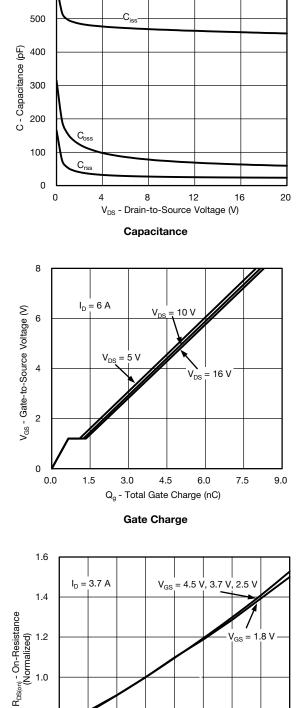






On-Resistance vs. Drain Current and Gate Voltage

S13-1270-Rev. A, 27-May-13



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

www.vishay.com

/ISHAY

30

25

20

15

10

5

0

I_D - Drain Current (A)

125

150

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1.0

0.8

0.6

- 50

- 25

0

25

On-Resistance vs. Junction Temperature

50

T_J - Junction Temperature (°C)

75

100

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SiA914ADJ

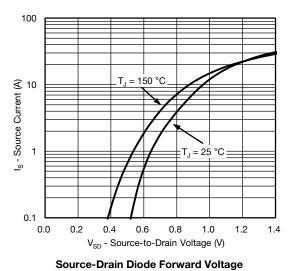
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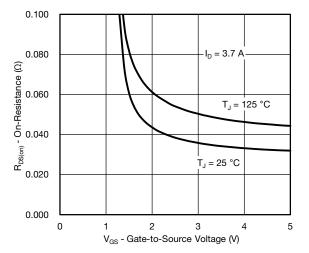


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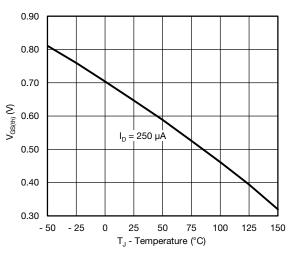
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

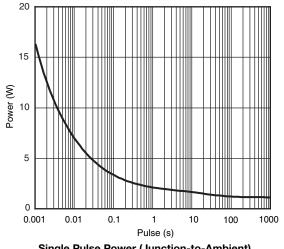




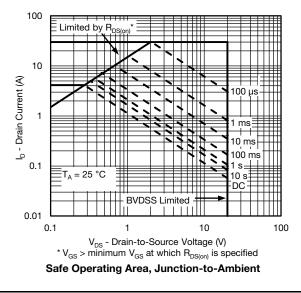
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power (Junction-to-Ambient)



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4

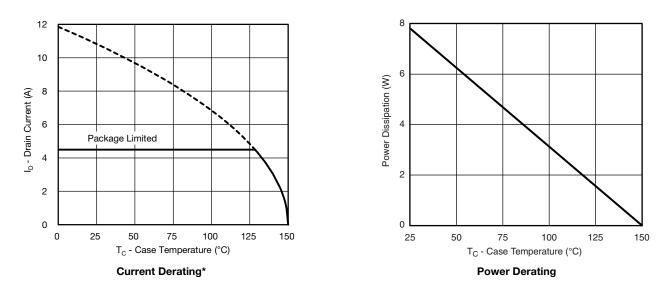
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

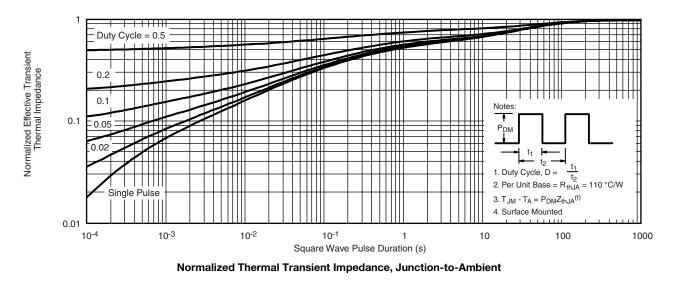


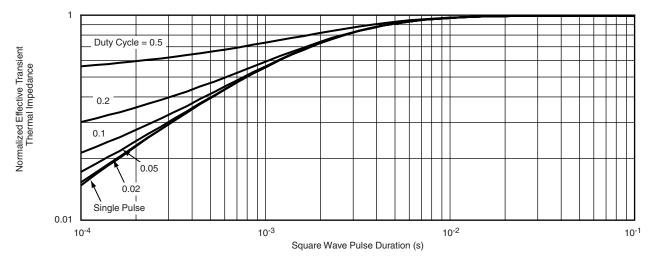
* The power dissipation P_D is based on T_{J(max.)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?62872</u>.



PowerPAK[®] SC70-6L

VISHA

b PIN2 PIN1 PIN3 _ ₹



b

PIN3

__ ₿

PIN2

PIN1

¥

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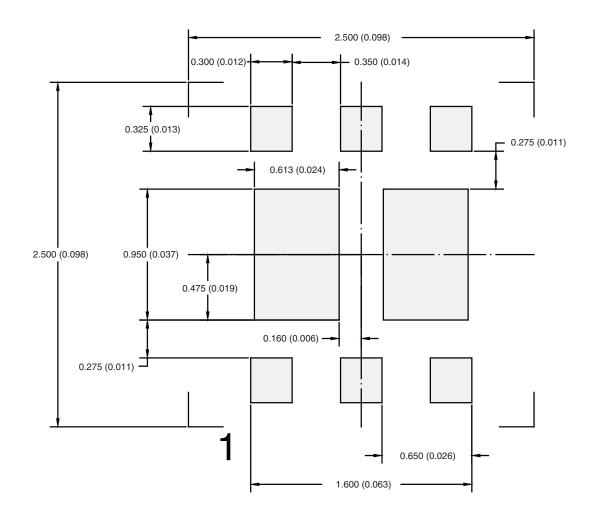
¹

Application Note 826

Vishay Siliconix



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

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Vishay

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